

Product Brief

TO293/TO294/TO295

TO-Can Lasers



Key Features

- Industry-leading chip designs
- Very high reliability with over 1 trillion field service hours
- TO56 package on a high-volume platform
- Up to 10-Gb/s DML (DFB), EML

Applications

- PON/fiber to the home ONU/OLT
- SONET/SDH
- Fibre Channel (FC)
- Gigabit Ethernet (GbE)

Overview

Broadcom supplies TO-cans that contain InP die as technology-enablers for TOSA/ROSA and module manufacturers. Broadcom has been a long-time industry leader in the design, fabrication, and quality assurance of high-performance laser and detector chips with over 1 trillion device field hours (< 1 FIT) since 2005—an unsurpassed record for ultra-high reliability.

Broadcom offers class-leading capabilities in the design and manufacture of direct modulated (DML) DFB lasers and electro-absorptive modulated (EML) lasers for solutions up to 10 Gb/s.

Ordering Information	
Product Code	Description
TO293Bx	2.5-Gb/s, 1.3-µm TDM and CWDM DFB TO Can
TO295Jx	2.5-Gb/s, 1.5-µm TDM and CWDM DFB TO Can
TO295J149x	2.5-Gb/s, 1.49-µm TDM DFB TO Can
TO294YSx	10-Gb/s, 1.5-μm TDM EML TO Can
TO294US157P	10-Gb/s, 1.577-μm TDM EML TO Can
TO295J1xxT	10-Gb/s, 1.5-μm CWDM DFB TO Can
TO293B1xxT	10-Gb/s, 1.27-µm to 1.45-µm CWDM DFB TO Can



Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Broadcom Limited:

<u>TO295J149-CDZ TO293B127-CDZAA TO293K-EFAX TO299K-EFAX TO293B127T-ECAX TO293BU-CDZ TO295J-CDZC TO295J151-CDZCA</u>